


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

| | | |
|----------------------|---|--------------------------------------|
| 1.1 Company |  | STMicroelectronics International N.V |
| 1.2 PCN No. | ANALOG MEMS SENSORS/25/15687 | |
| 1.3 Title of PCN | ST Manufacturing Reshaping (Analog_FE+EWS BCD9 AG200toSG8E_all): Qualification of SG8E (Singapore) as new FE location and SGP plant (Singapore) as new EWS Location for Adv BCD9 products | |
| 1.4 Product Category | Please refer to the impacted Product list | |
| 1.5 Issue date | 2025-07-29 | |

2. PCN Team

| | |
|----------------------------------|--|
| 2.1 Contact supplier | |
| 2.1.1 Name | PIKE EMMA |
| 2.1.2 Phone | +44 1628896111 |
| 2.1.3 Email | emma.pike@st.com |
| 2.2 Change responsibility | |
| 2.2.1 Product Manager | Nicola LIPORACE,Domenico ARRIGO |
| 2.1.2 Marketing Manager | Fabio CHELLI,Elena Maria PERNIGOTTI,Matteo AMADEO |
| 2.1.3 Quality Manager | Alessandro PLATINI,Alberto BIGNAZZI,Marcello Donato MENCHISE |

3. Change

| | | |
|---------------------------------|---------------------------------|--|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| Manufacturing reshaping program | Manufacturing reshaping program | New Front end plant : SG8E New FE EWS plant : SGP |

4. Description of change

| | | |
|---|--|--|
| | Old | New |
| 4.1 Description | Front end plant : AG8 (Italy) FE EWS plant : AF6E (Italy) | Front end plant : SG8E (Singapore) FE EWS plant : SGP (Singapore) |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No Impact. The products guarantee the same quality and electrical characteristics as per current production. | |

5. Reason / motivation for change

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|----------------------|--|
| 5.1 Motivation | In the frame of ST manufacturing reshaping program (refer to Corporate PCI 15383 - Early Notification), following the continuous improvement of our service and to increase production Capacity, ST Microelectronics is announcing the qualification of SG8E (Singapore) as FE Location and SGP (Singapore) as FE EWS plant for the impacted Products in Adv BCD9 Technology. Please be advised that the enclosed list of products and dates could be subject to change. Such modifications may occur as part of the ongoing transformation program and will be communicated as and when available. |
| 5.2 Customer Benefit | SERVICE CONTINUITY |

6. Marking of parts / traceability of change

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|-----------------|--|
| 6.1 Description | Traceability of change will be ensured by an internal codification (Finished Good/Type) printed on the carton box label. |
|-----------------|--|

7. Timing / schedule

| | |
|-------------------------------------|--------------|
| 7.1 Date of qualification results | 2026-07-15 |
| 7.2 Intended start of delivery | 2027-01-15 |
| 7.3 Qualification sample available? | Upon Request |

8. Qualification / Validation

| | | | |
|--|-------------|------------|--|
| 8.1 Description | | | |
| 8.2 Qualification report and qualification results | In progress | Issue Date | |

| 9. Attachments (additional documentations) | | |
|---|--|--|
| 15687 Public product.pdf 15687 Qualification Plan Detail_EWS adv BCD9 BSM - BCD110.pdf | | |

| 10. Affected parts | | |
|-------------------------|-------------------------|--------------------------|
| 10. 1 Current | | 10.2 New (if applicable) |
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No |
| | STDRIVE101 | |
| | STDRIVE101TR | |

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